



LTCC SURFACE MOUNT

# Low Pass Filter

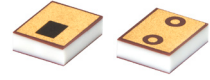
## LFHK-630+

50Ω

DC to 630 MHz

### THE BIG DEAL

- Low Insertion Loss, 1.3 dB Typ.
- Passband Return Loss, 14 dB Typ.
- Stopband Rejection, 84 dB Typ.
- 1008 Surface Mount Footprint
- Power Handling: 9 W
- Shielded Construction: Prevents De-Tuning & EMI
- Protected by US Patents 11,638,370 and 11,744,057

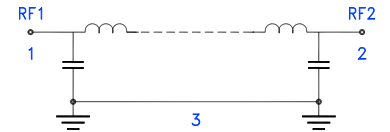


Generic photo used for illustration purposes only

### APPLICATIONS

- Test and Measurement Equipment
- Microwave Transmitters / Receivers
- Harmonic Rejection
- Satellite Communications

### FUNCTIONAL DIAGRAM



### PRODUCT OVERVIEW

The LFHK-630+ is a passive RF component designed for signal conditioning in low-frequency circuits. It utilizes ceramic-based construction to achieve stable electrical behavior across a broad operating range. The device supports bidirectional signal flow and is optimized for integration into compact layouts, making it suitable for dense PCB designs. Its surface-mount format aligns with standard automated assembly processes, and the internal structure is engineered to minimize parasitic effects that could impact performance at microwave frequencies. The component is built to maintain consistent characteristics under varying environmental conditions, contributing to overall system reliability.

### ELECTRICAL SPECIFICATIONS<sup>1,2,3</sup> AT +25°C

Parameter	F#	Frequency (MHz)	Min.	Typ.	Max.	Units	
Passband	Insertion Loss	DC-F1	DC - 630	—	1.3	1.9	dB
	Freq. Cut-Off <sup>4</sup>	Fc	770	—	3	—	
	Return Loss	DC-F1	DC - 630	9	14	—	
Stopband	Rejection	F2-F3	1000 - 1700	20	28	—	dB
		F3-F4	1700 - 4200	66	84	—	
		F4-F5	4200 - 10000	—	60	—	
		F5-F6	10000 - 15000	—	52	—	
		F6-F7	15000 - 40000	—	20	—	

1. Tested in Evaluation Board P/N TB-LFHK-630+.

2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.

3. This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

4. Typical variation ± 5%.

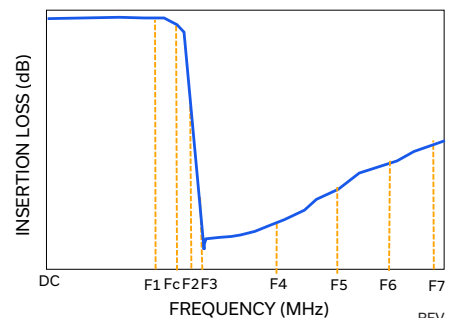
### ABSOLUTE MAXIMUM RATINGS<sup>5</sup>

Operating Temperature	-55°C to +125°C
Storage Temperature	-55°C to +125°C
Input Power <sup>6</sup>	9 W @ +25°C

5. Permanent damage may occur if any of these limits are exceeded.

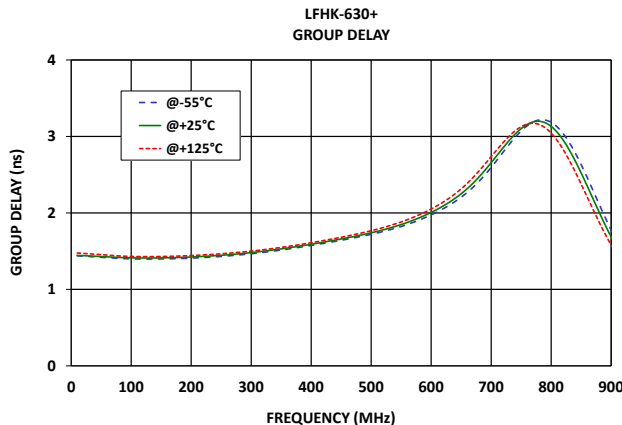
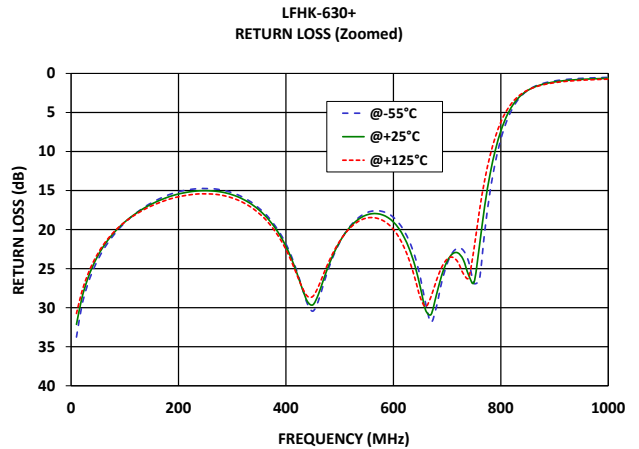
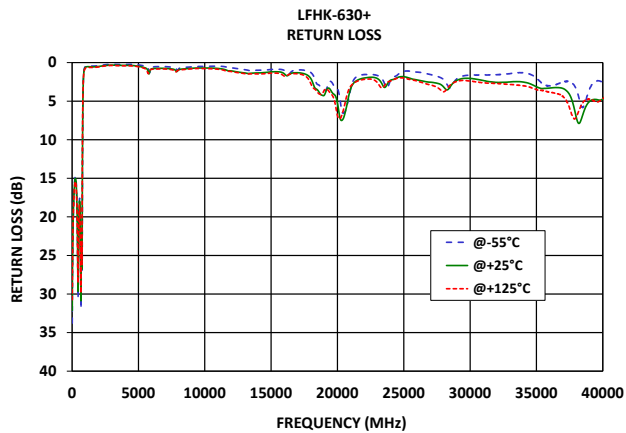
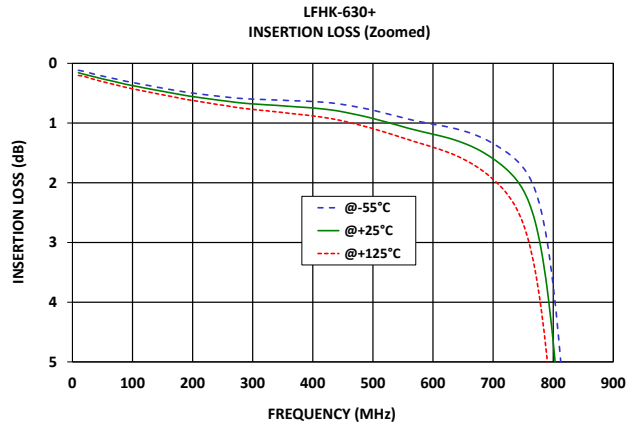
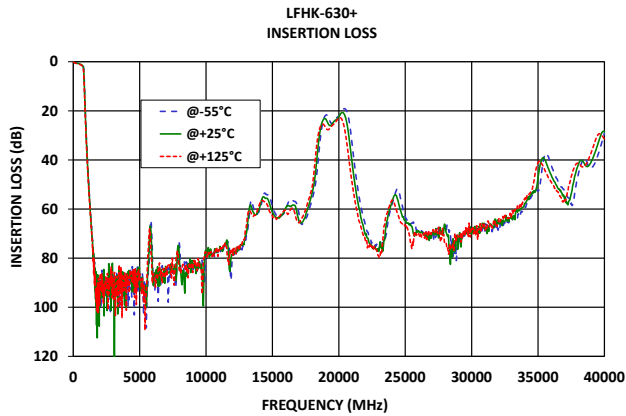
6. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 1.1 W at +125°C.

### TYPICAL FREQUENCY RESPONSE





### TYPICAL PERFORMANCE GRAPHS





### FUNCTIONAL DIAGRAM

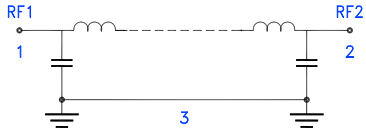
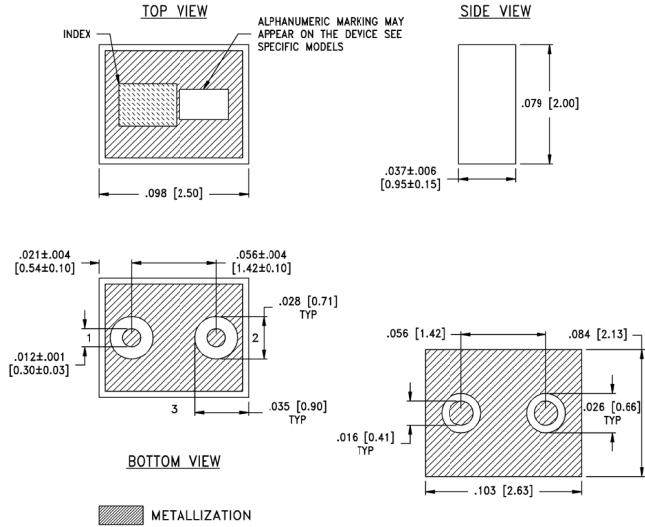


Figure 1. LFHK-630+ Functional Diagram

### PAD DESCRIPTION

Function	Pad Number	Description
RF1 <sup>2</sup>	1	Connects to RF Input Port
RF2 <sup>2</sup>	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-798)

### CASE STYLE DRAWING



Weight: .019grms.  
Dimensions are in inches (mm).

Tolerances: 2Pl. ± .01; 3Pl. ± .005

### PRODUCT MARKING\*: W2

\*Marking may contain other features or characters for internal lot control.



### SUGGESTED PCB LAYOUT

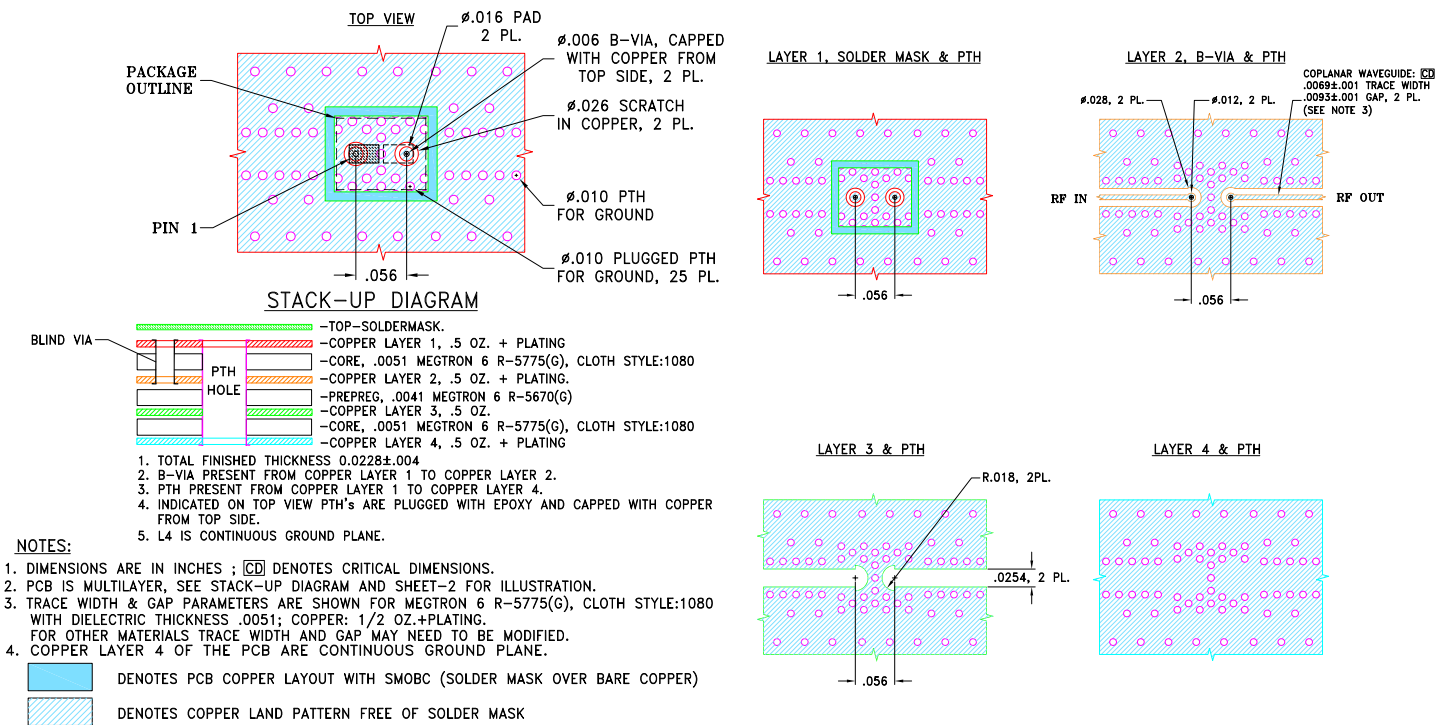


Figure 2. Suggested PCB Layout



LTCC SURFACE MOUNT

# Low Pass Filter

## LFHK-630+

50Ω

DC to 630 MHz

ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASHBOARD

[CLICK HERE](#)

Performance Data & Graphs	Data Graphs S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	NL1008C-12 Lead Finish: Gold over Electroless Nickel
RoHS/REACH Status	Compliant
Tape and Reel	F75
Suggested Layout for PCB Design	PL-798
Evaluation Board	TB-LFHK-630+ Gerber File
Environmental Rating	ENV06T10

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at [www.minicircuits.com/terms/viewterm.html](http://www.minicircuits.com/terms/viewterm.html)



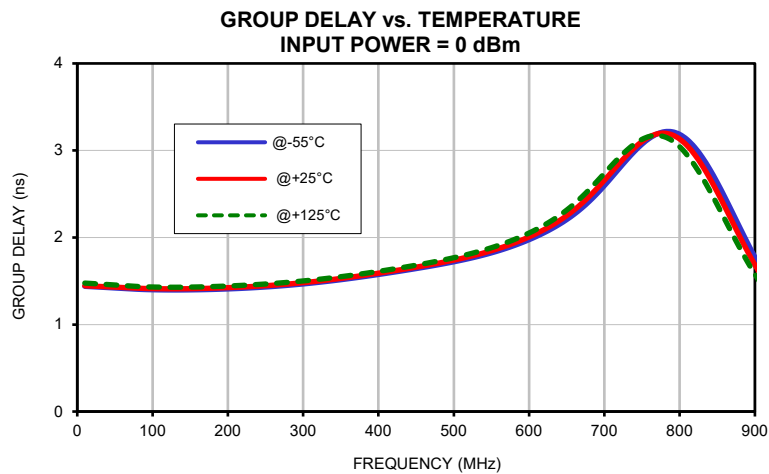
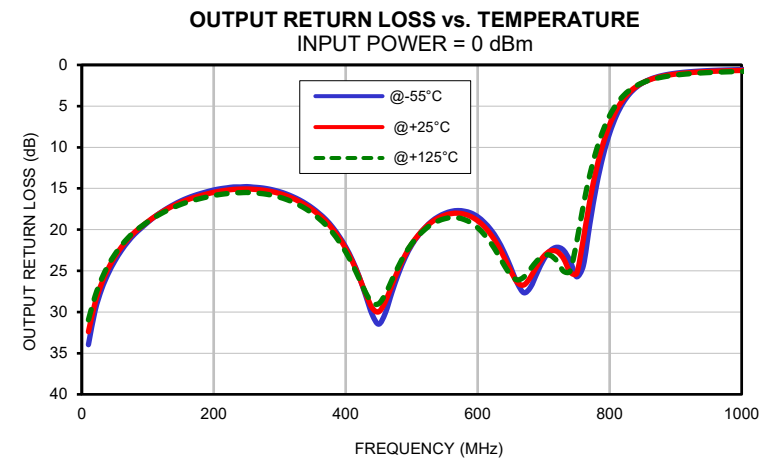
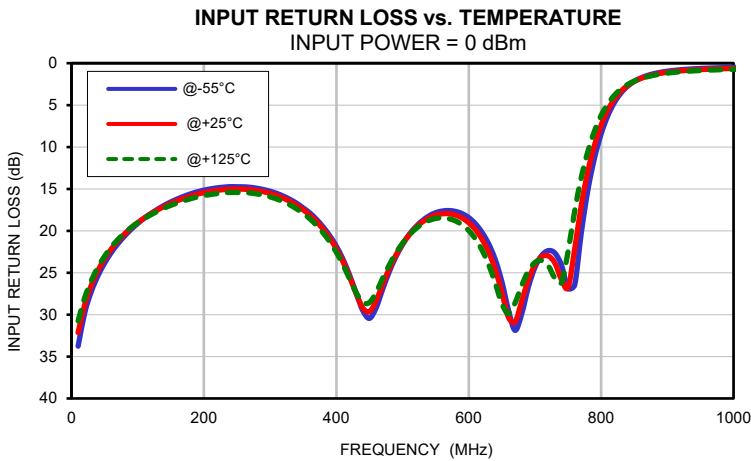
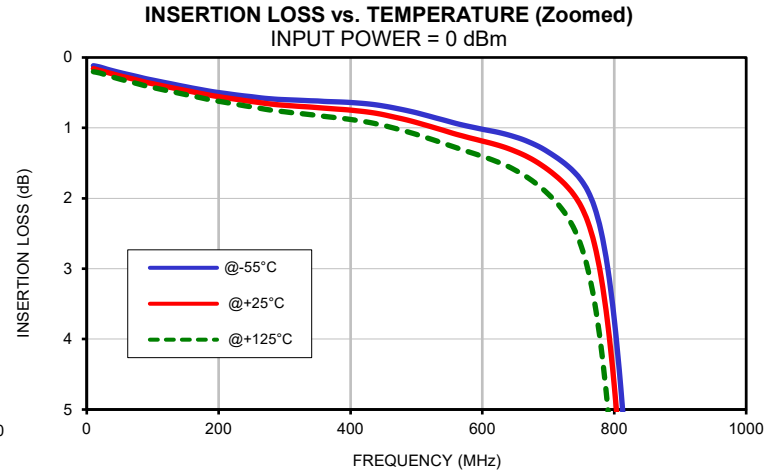
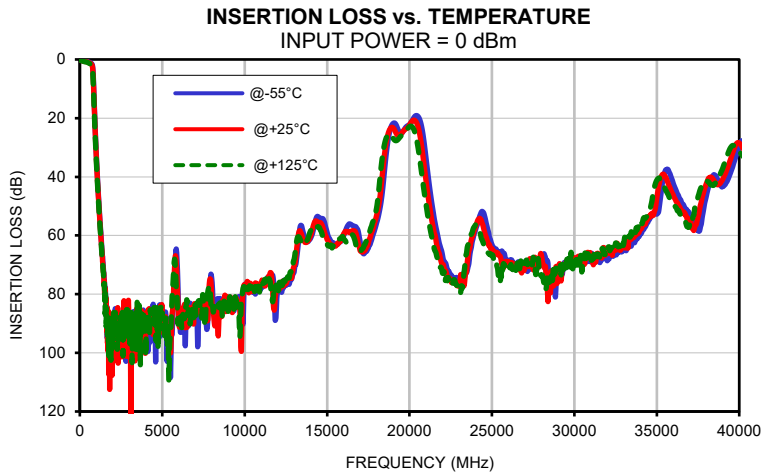
Typical Performance Data

FREQ.  (MHz)	INSERTION LOSS			INPUT RETURN LOSS			OUTPUT RETURN LOSS		
	(dB)			(dB)			(dB)		
	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C
10	0.12	0.16	0.20	33.76	32.14	30.75	33.97	32.40	30.96
50	0.21	0.26	0.31	23.86	23.34	23.04	23.81	23.31	23.02
100	0.32	0.37	0.43	19.13	19.02	19.03	19.11	19.02	19.05
200	0.50	0.56	0.62	15.15	15.44	15.80	15.19	15.47	15.85
300	0.60	0.68	0.77	15.28	15.54	15.95	15.40	15.63	16.07
350	0.62	0.71	0.82	17.28	17.50	17.93	17.41	17.62	18.06
400	0.64	0.75	0.88	21.83	22.15	22.56	22.12	22.31	22.73
450	0.69	0.81	0.96	30.45	29.64	28.55	31.47	29.97	28.98
500	0.78	0.92	1.09	21.65	21.57	21.49	21.87	21.73	21.70
550	0.91	1.06	1.25	17.84	18.12	18.53	18.04	18.25	18.67
600	1.02	1.19	1.41	18.42	19.03	19.97	18.44	18.93	19.78
620	1.06	1.24	1.47	20.18	21.00	22.29	20.02	20.62	21.64
630	1.08	1.26	1.51	21.55	22.54	24.02	21.21	21.85	22.91
700	1.34	1.60	1.94	24.37	24.06	23.78	23.62	23.23	23.15
770	2.12	2.65	3.47	20.24	16.95	13.64	19.26	16.41	13.29
790	2.99	3.78	4.97	11.31	9.76	8.09	11.03	9.55	7.94
800	3.72	4.66	6.04	8.43	7.38	6.24	8.26	7.24	6.14
810	4.70	5.78	7.30	6.28	5.60	4.85	6.17	5.50	4.79
850	10.48	11.77	13.44	2.17	2.18	2.14	2.18	2.16	2.15
910	20.10	21.23	22.70	0.86	0.99	1.10	0.91	1.02	1.15
1000	32.26	33.24	34.47	0.51	0.63	0.73	0.57	0.67	0.79
1500	76.42	79.76	78.36	0.45	0.55	0.64	0.42	0.51	0.61
1700	94.96	85.44	92.80	0.45	0.55	0.62	0.42	0.51	0.60
2000	89.70	95.03	93.06	0.40	0.50	0.56	0.40	0.48	0.57
2500	87.90	95.38	90.99	0.28	0.38	0.43	0.34	0.42	0.51
3000	92.60	91.28	90.35	0.21	0.33	0.37	0.28	0.37	0.45
4000	87.82	87.64	101.22	0.24	0.36	0.42	0.30	0.41	0.50
4200	96.95	84.96	90.60	0.23	0.36	0.42	0.32	0.44	0.53
5000	87.19	90.20	86.35	0.30	0.48	0.54	0.44	0.59	0.69
6000	86.87	89.84	87.40	0.62	0.81	0.86	0.69	0.80	0.88
7000	86.40	85.63	83.64	0.52	0.75	0.83	0.60	0.76	0.88
8000	74.58	80.75	85.15	0.91	0.98	1.00	1.10	1.07	1.06
9000	82.76	83.11	85.88	0.55	0.74	0.81	0.62	0.80	0.90
10000	76.84	76.76	77.76	0.49	0.70	0.78	0.54	0.74	0.84
11000	77.31	76.73	76.90	0.47	0.76	0.86	0.52	0.78	0.93
12000	79.04	78.35	76.35	0.70	1.08	1.16	0.74	1.04	1.19
13000	72.46	70.39	68.12	0.91	1.34	1.43	0.99	1.29	1.43
14000	60.92	60.15	58.40	0.99	1.34	1.46	1.03	1.32	1.47
15000	58.94	61.37	62.84	0.89	1.20	1.37	0.87	1.18	1.36
16000	60.08	59.47	60.98	1.02	1.46	1.75	0.90	1.33	1.68
17000	61.99	65.11	65.62	0.94	1.31	1.45	1.00	1.37	1.56
18000	55.74	53.22	50.69	1.29	2.09	2.76	1.26	1.80	2.31
19000	21.85	23.29	26.79	3.56	4.24	3.61	4.20	4.14	3.49
20000	22.18	22.30	22.89	3.41	5.24	6.86	2.90	3.83	5.02
21000	33.59	41.25	49.36	3.38	3.36	3.05	4.39	3.66	3.19
22000	66.73	70.54	72.88	1.57	2.01	2.19	1.64	2.14	2.36
23000	76.86	77.27	79.11	1.68	2.06	2.59	1.79	2.39	3.11
24000	58.19	57.15	56.33	2.34	2.29	2.40	2.17	2.31	2.54
25000	63.10	64.47	66.50	1.13	1.83	2.00	1.18	1.73	1.94
26000	68.50	68.87	70.01	1.24	2.25	2.40	1.25	1.88	2.10
30000	69.65	70.14	68.83	1.62	2.05	2.39	1.69	2.37	2.78
31000	69.00	67.86	68.49	1.60	2.32	2.61	1.62	2.29	2.59
32000	68.59	64.96	65.41	1.58	2.57	2.73	1.61	2.23	2.45
33000	63.70	62.55	62.71	1.43	2.51	2.83	1.58	2.19	2.60
34000	59.05	57.68	56.22	1.34	2.52	3.02	1.66	2.45	3.10
35000	52.74	47.20	41.17	2.07	3.13	3.52	2.40	3.47	3.86
36000	42.31	46.24	49.04	3.01	3.31	3.86	2.79	3.64	4.27
37000	53.14	56.07	56.16	2.49	3.35	4.34	2.61	3.77	5.20
38000	46.66	42.39	41.34	3.47	7.08	7.07	5.79	6.10	4.94
40000	29.26	28.51	31.48	2.56	4.69	4.66	2.74	3.67	4.02

## Typical Performance Data

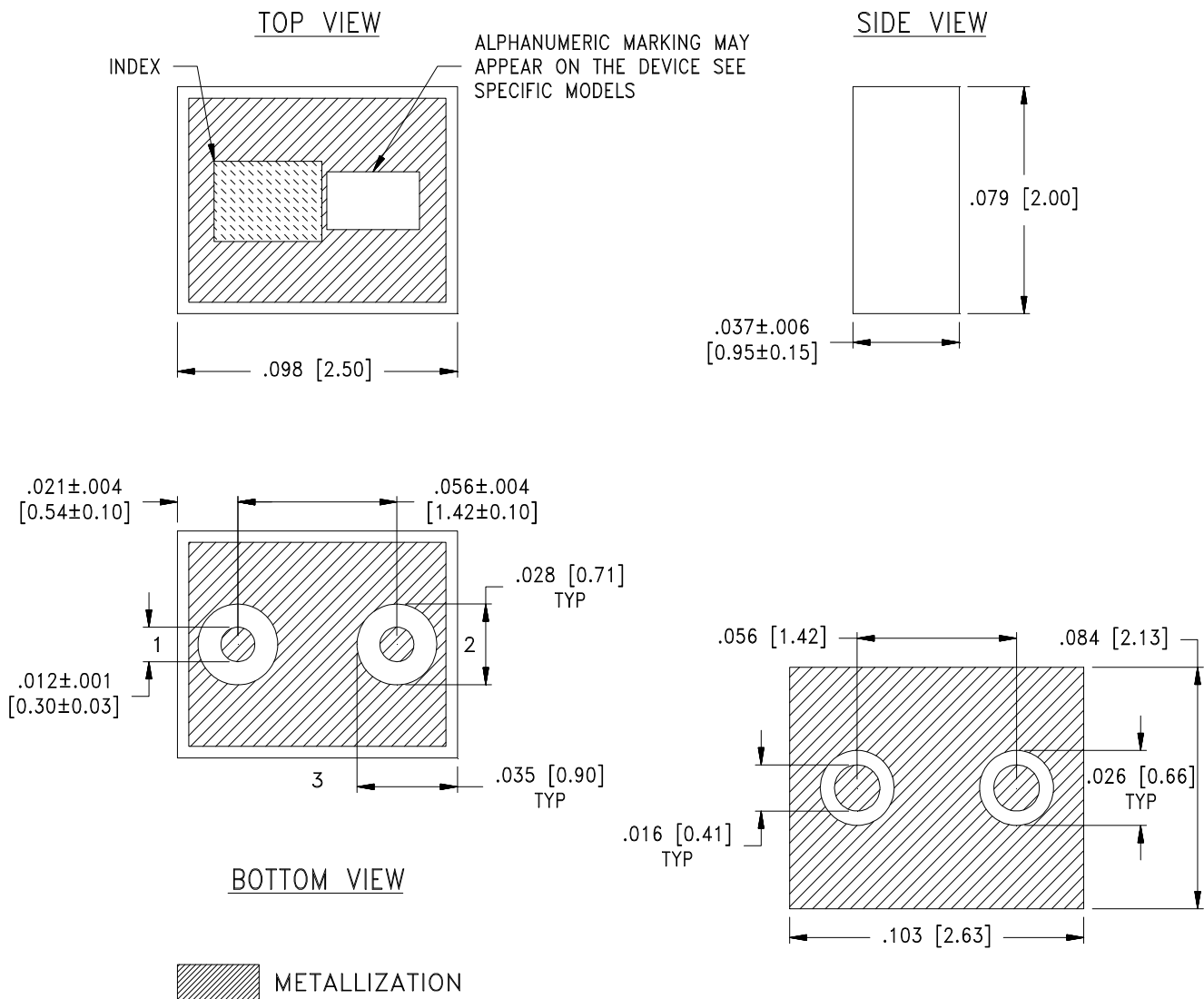
FREQ.  (MHz)	GROUP DELAY		
	(nsec)		
	@-55°C	@+25°C	@+125°C
10	1.44	1.45	1.48
20	1.43	1.44	1.47
30	1.43	1.44	1.47
40	1.42	1.43	1.46
50	1.42	1.43	1.45
60	1.42	1.43	1.45
70	1.41	1.42	1.44
80	1.41	1.42	1.44
90	1.40	1.41	1.43
100	1.40	1.41	1.43
110	1.40	1.41	1.43
120	1.40	1.41	1.43
200	1.41	1.42	1.44
220	1.42	1.43	1.45
240	1.43	1.44	1.46
260	1.44	1.45	1.47
280	1.45	1.47	1.49
300	1.47	1.48	1.50
320	1.48	1.50	1.52
340	1.50	1.52	1.54
360	1.53	1.54	1.56
380	1.55	1.56	1.58
400	1.57	1.59	1.61
420	1.60	1.62	1.64
440	1.63	1.64	1.67
460	1.66	1.67	1.70
480	1.69	1.71	1.73
500	1.72	1.74	1.77
520	1.76	1.78	1.81
540	1.80	1.82	1.86
560	1.85	1.88	1.91
580	1.91	1.94	1.98
600	1.97	2.01	2.05
610	2.01	2.05	2.09
620	2.05	2.09	2.14
630	2.10	2.14	2.19

## Typical Performance Curves



## Outline Dimensions

## NL1008C-12



SUGGESTED LAYOUT FOR PCB LAND PATTERN

PATTERN TO BE WITHIN ±.002

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3Pl. ± .005

### Notes:

1. Open style, Ceramic base.
2. Termination finish: **as shown below or indicated on Data sheet.**  
For RoHS Case Styles: Gold plate over nickel plate. All models, (+) suffix.
3. Weight: .019 grams.
4. Pad tolerance is non-cumulative.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



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RF/IF MICROWAVE COMPONENTS

## DEVICE ORIENTATION IN T&R

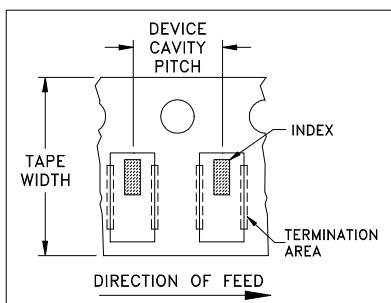


ILLUSTRATION 1

Applicable Case Styles
FV1206-1 FV1206-3

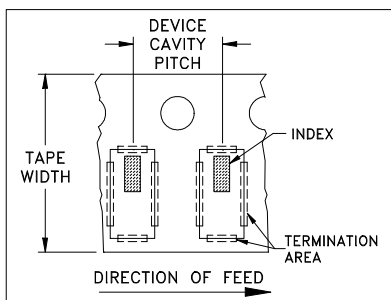


ILLUSTRATION 2

Applicable Case Styles
FV1206-4 FV1206-5 FV1206-6 FV1206-7 FV1206-9

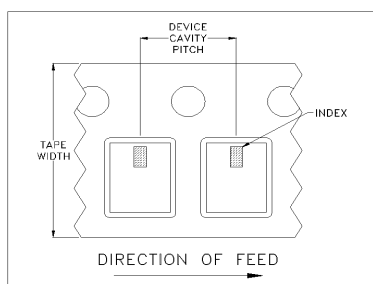


ILLUSTRATION 3

Applicable Case Styles
FV1206-11 FV1206-12 GE0805C-18 NL1008C-6 NL1008C-7 NL1008C-9 NL1008C-10 NL1008C-12

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: [www.minicircuits.com/pages/pdfs/tape.pdf](http://www.minicircuits.com/pages/pdfs/tape.pdf)

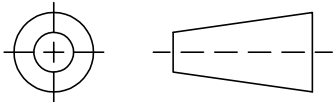


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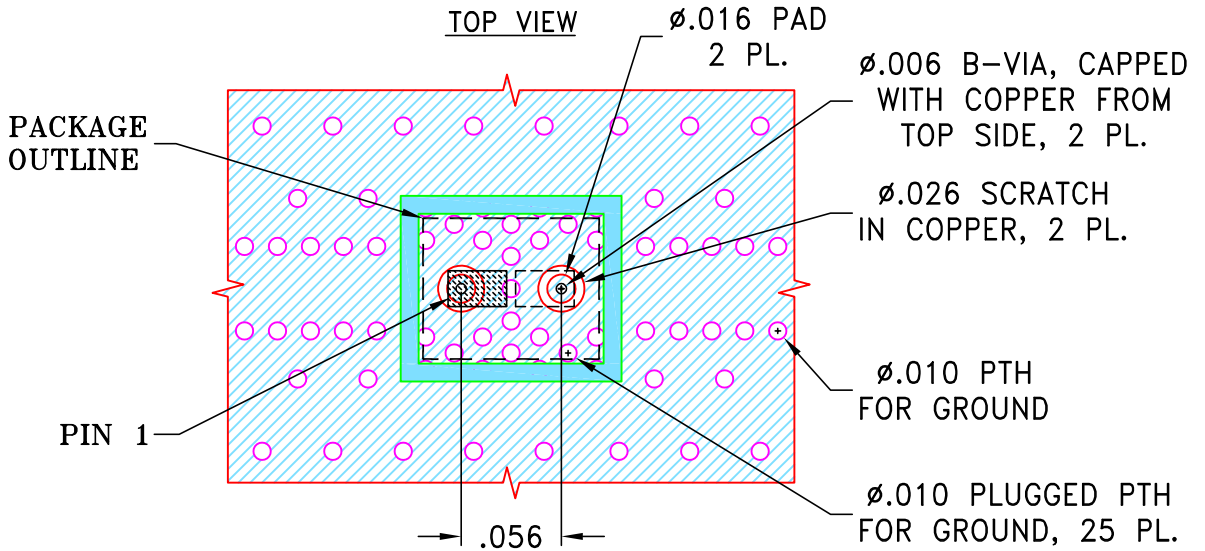
THIRD ANGLE PROJECTION



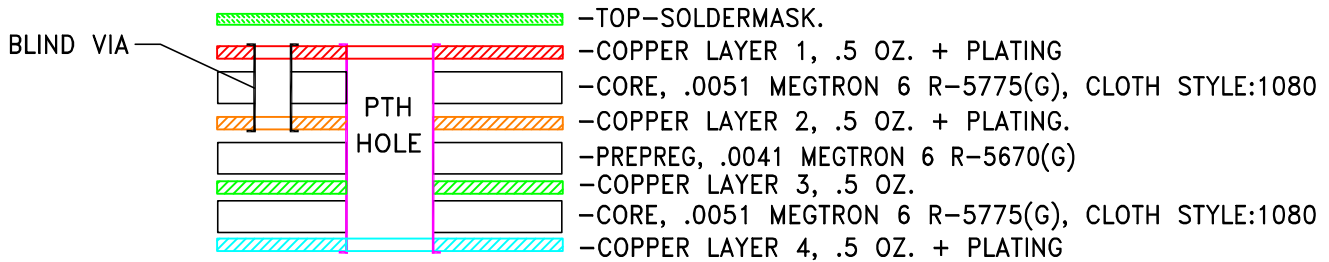
REVISIONS

REV OR	ECN No.	DESCRIPTION	DATE	DR	AUTH
	ECO-023057	NEW RELEASE	SEP 24	AGS	GT

SUGGESTED MOUNTING CONFIGURATION FOR NL1008C-9 CASE STYLE



STACK-UP DIAGRAM



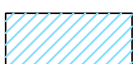
1. TOTAL FINISHED THICKNESS 0.0228±.004 .
2. B-VIA PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 2.
3. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
4. INDICATED ON TOP VIEW PTH'S ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
5. L4 IS CONTINUOUS GROUND PLANE.

NOTES:

1. PCB IS MULTILAYER, SEE STACK-UP DIAGRAM AND SHEET-2 FOR ILLUSTRATION.
2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON6 R-5775(G), CLOTH STYLE:1080 WITH DIELECTRIC THICKNESS .0051; COPPER: 1/2 OZ.+PLATING.  
FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
3. COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN AGS	14 SEP 24
TOLERANCES ON:	CHECKED MD	16 SEP 24
2 PL DECIMALS ±	APPROVED GTP	17 SEP 24
3 PL DECIMALS ± .002		
ANGLES ±		
FRACTIONS ±		



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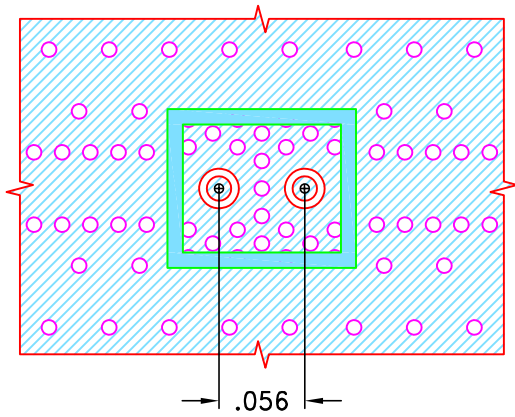
13 Neptune Avenue  
Brooklyn NY 11235

PL, NL1008C-9, TB-LFHK-XXXX+

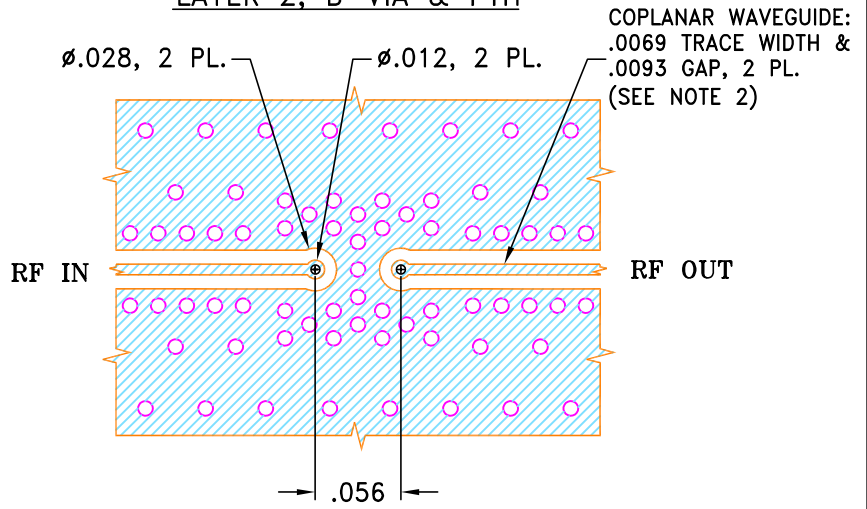
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SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-798	OR
FILE:	98-PL-798	SCALE:	SHEET:
		9:1	1 OF 2

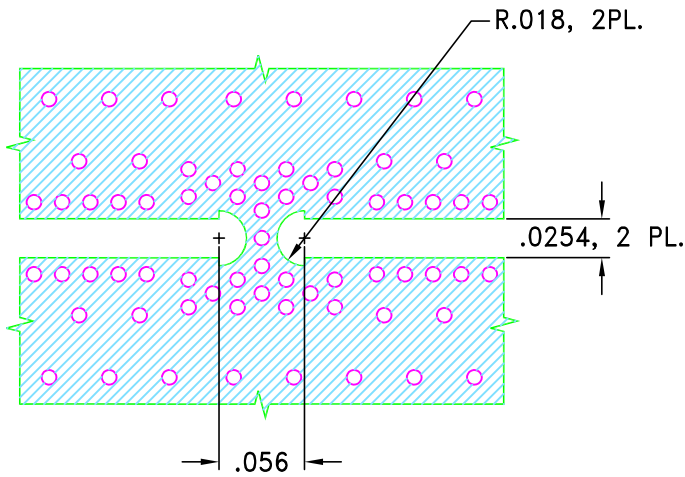
LAYER 1, SOLDER MASK & PTH



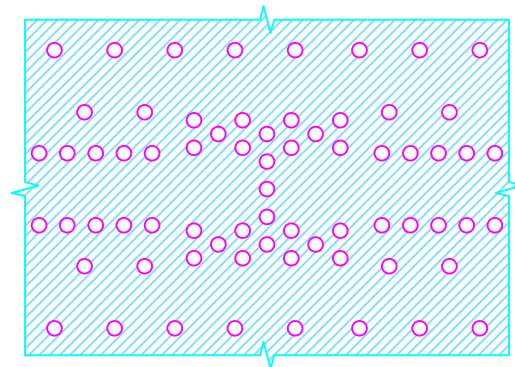
LAYER 2, B-VIA & PTH



LAYER 3 & PTH



LAYER 4 & PTH



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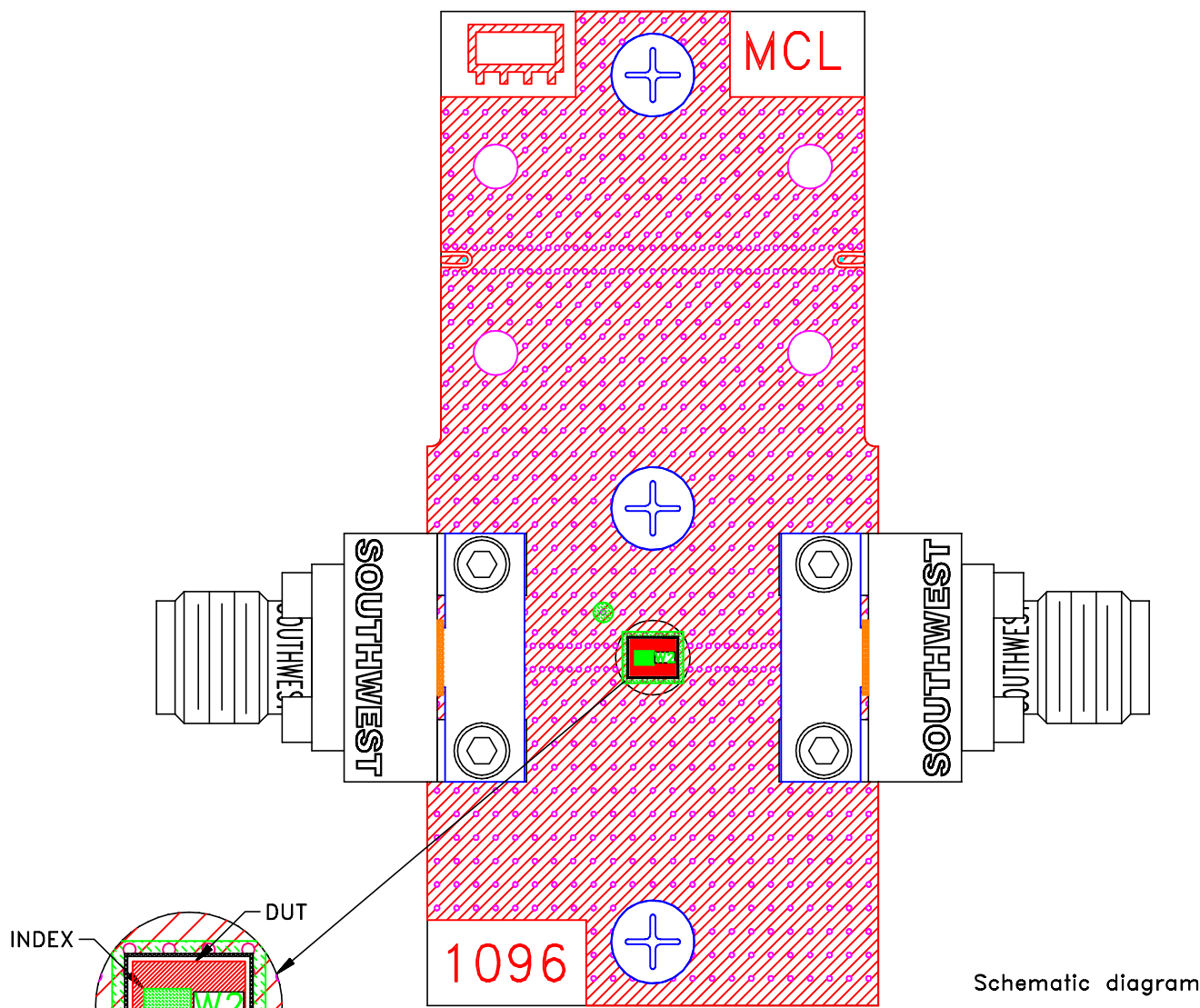
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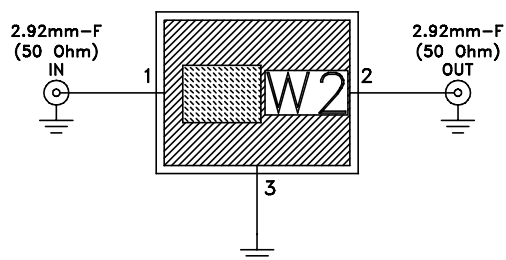
SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-798	REV: OR
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# Evaluation Board and Circuit

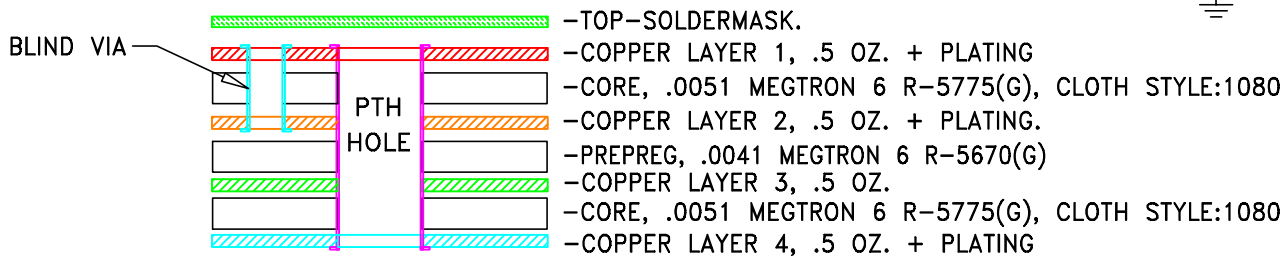
TB-LFHK-630+



Schematic diagram




## STACK-UP DIAGRAM



### Notes:

1. PCB Material: MEGTRON-6 R5775(G) OR Equivalent, Dielectric Constant=3.6
2. Total finished thickness: .023 inch
3. 50 Ohm 2.92mm Female End Launch Connector.

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutectic Process 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Test B,B1, 95% Coverage
Thermal Shock	-55° to +125°C, 15 min dwell,250 cycles	MIL-STD-202, Method 107
Bend Test	1mm, deflection for 5 seconds Span of bending: 2.75"	--
High Temp Storage	125°C to 1000 Hrs	---